

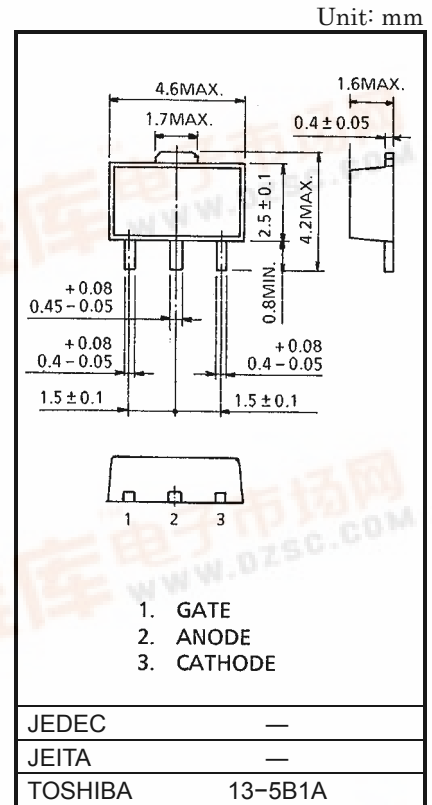
URSF05G49-1P,URSF05G49-3P,URSF05G49-5P

LOW POWER SWITCHING AND CONTROL APPLICATIONS

- Repetitive Peak Off-State Voltage: $V_{DRM} = 400V$
Repetitive Peak Reverse Voltage : $V_{RRM} = 400V$
- Average On-State Current : $I_T(AV) = 500mA$
- Reduce a Quantity of Parts and Manufacturing Process Because of Built-in RGK : $RGK = 1k\Omega, 2.7k\Omega, 5.1k\Omega$ (Typ.)

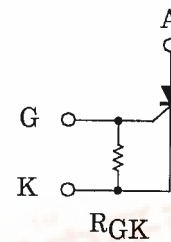
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATINGS	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	V_{DRM} V_{RRM}	400	V
Non-Repetitive Peak Reverse Voltage (Non-Repetitive<5ms, $T_j = 0\sim 125^\circ C$)	V_{RSM}	500	V
Average On-State Current (Half Sine Waveform)	$I_T(AV)$	500	mA
R.M.S On-State Current	$I_T(RMS)$	800	mA
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	9 (50Hz)	A
		10 (60Hz)	
I^2t Limit Value	I^2t	0.4	A^2s
Critical Rate of Rise of On-State Current (Note 1)	di / dt	10	$A / \mu s$
Peak Gate Power Dissipation	P_{GM}	0.1	W
Average Gate Power Dissipation	$P_{G(AV)}$	0.01	W
Peak Forward Gate Voltage	V_{FGM}	3.5	V
Peak Reverse Gate Voltage	V_{RGM}	-5	V
Peak Forward Gate Current	I_{GM}	125	mA
Junction Temperature	T_j	-40~125	$^\circ C$
Storage Temperature Range	T_{stg}	-40~125	$^\circ C$



Weight: 0.2 g

EQUIVALENT CIRCUIT



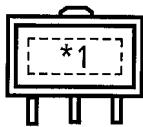
NOTE 1: di / dt Test condition
 $I_G = 5mA, t_{gw} = 10\mu s,$
 $t_{gr} \leq 250ns$

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

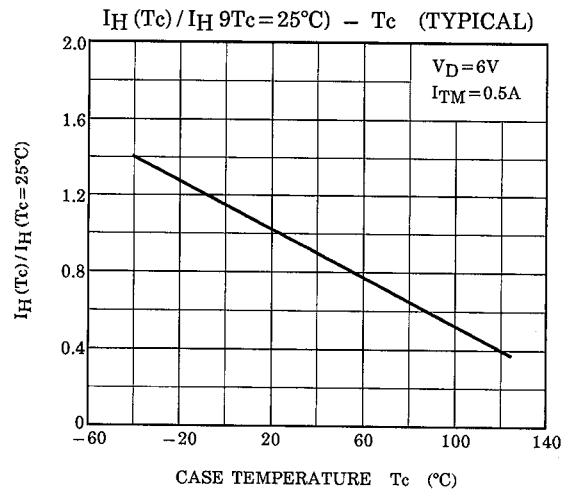
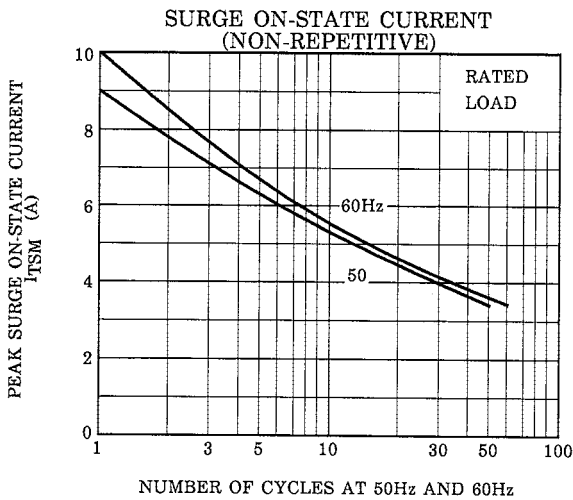
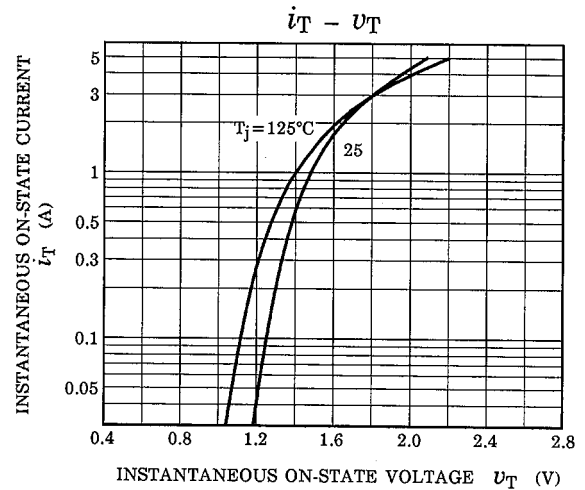
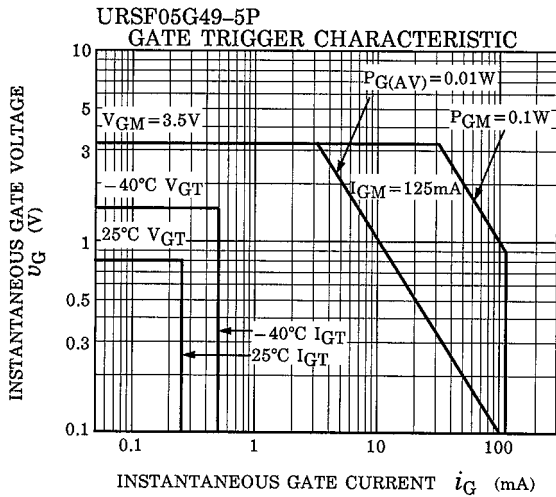
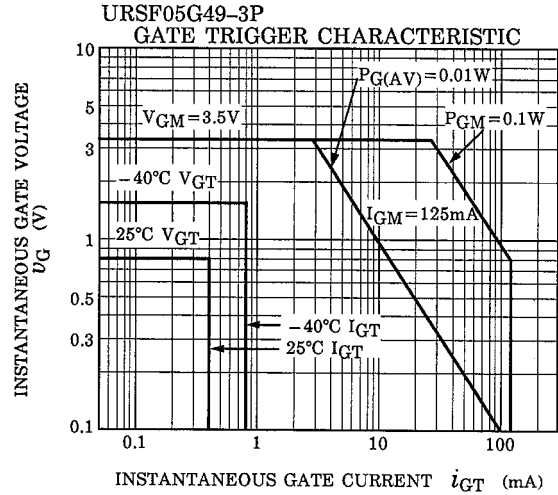
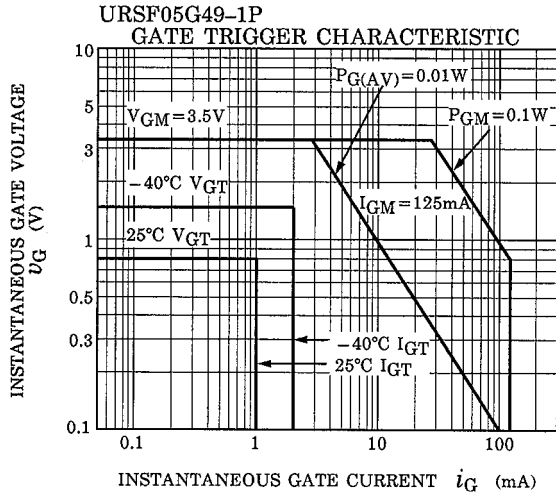
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current		I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM} = \text{Rated}$	—	—	10	μA
Peak On-State Voltage		V_{TM}	$I_{TM} = 1\text{A}$	—	—	1.5	V
Gate Trigger Voltage		V_{GT}	$V_D = 6\text{V}, R_L = 100\Omega$	—	—	0.8	V
Gate Trigger Current	URSF05G49-1P	I_{GT}		250	700	1000	μA
	URSF05G49-3P			100	250	400	
	URSF05G49-5P			50	160	250	
Holding Current	URSF05G49-1P	I_H	$I_{TM} = 500\text{mA}, V_D = 6\text{V}$	—	—	6	mA
	URSF05G49-3P			—	—	3	
	URSF05G49-5P			—	—	2	
Resistor Between Gate and Cathode	URSF05G49-1P	R_{GK}	—	700	1000	1300	Ω
	URSF05G49-3P			1890	2700	3510	
	URSF05G49-5P			3570	5100	6630	
Critical Rate of Rise of Off-State Voltage	URSF05G49-1P	d_v / dt	$V_{DRM} = \text{Rated}, \text{Exponential Rise}$	—	200	—	V / μs
	URSF05G49-3P			—	70	—	
	URSF05G49-5P			—	40	—	
Turn-On Time		t_{gt}	$V_D = \text{Rated}, i_G = 5\text{mA}$	—	—	1.5	μs
Thermal Resistance		$R_{th(j-a)}$	Junction to Ambient	—	—	70	$^{\circ}\text{C} / \text{W}$

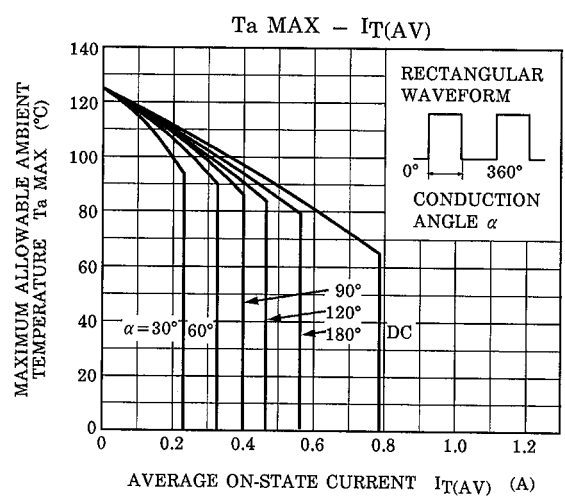
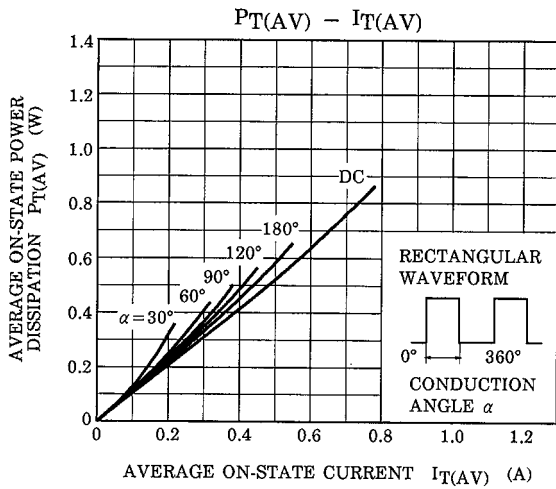
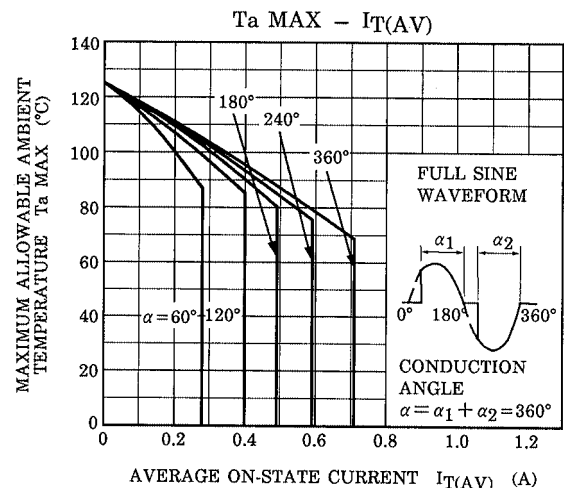
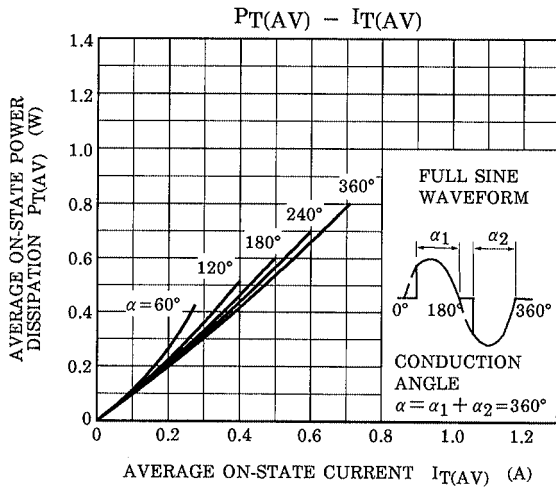
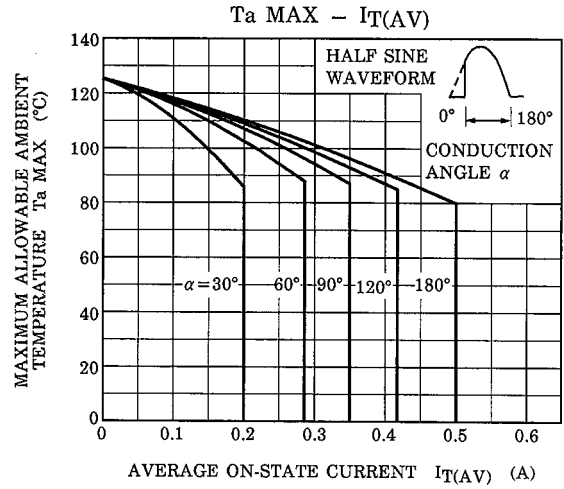
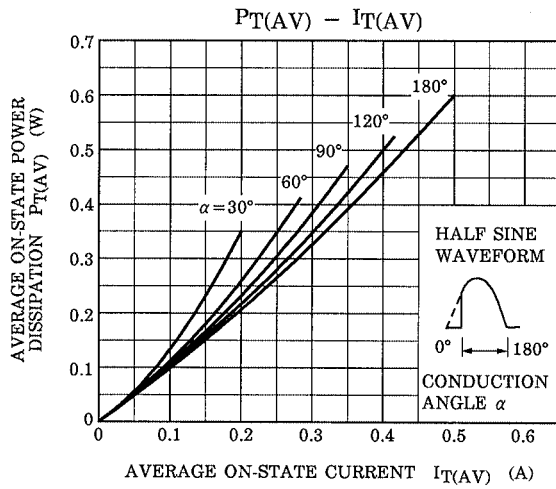
Note: Thermal Resistance Test Condition
Use 0.6×30×30mm Alumina Plate

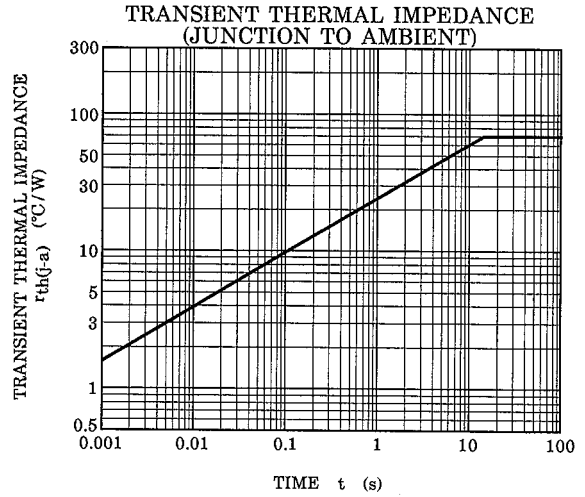
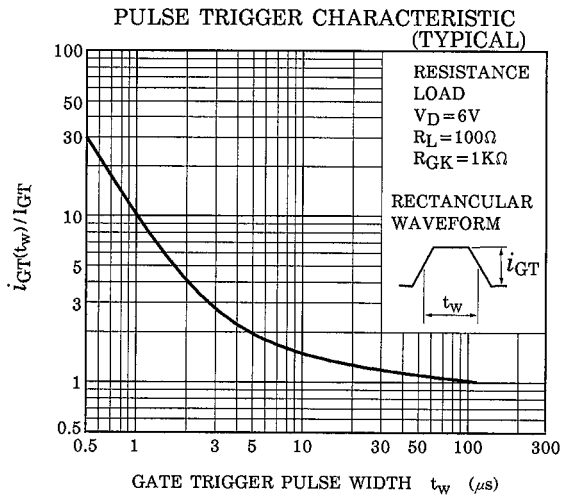
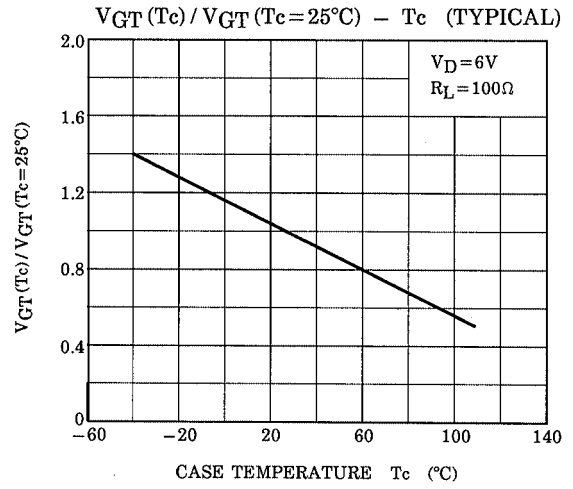
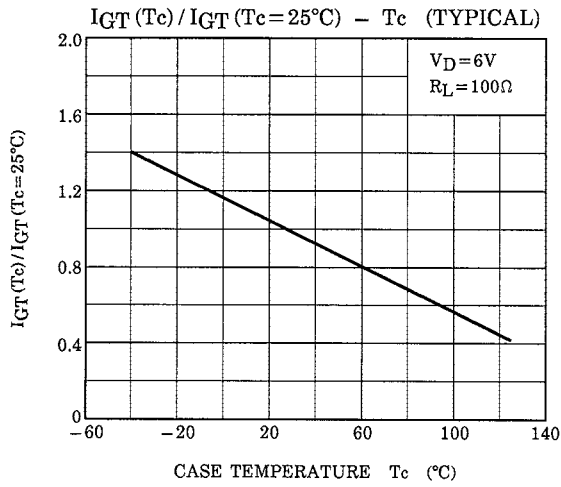
MARK



NUMBER	TYPE	MARK
* 1	URSF05G49-1P	PB
	URSF05G49-3P	PC
	URSF05G49-5P	PD







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